AMENDMENTS TO THE CLAIMS

Please amend claims 1, 3, 6-8, 10-11, 14, 16-19, 22 and 25-27 as follows.

1. (Currently amended) An apparatus, comprising:

a buried tapered waveguide disposed in a semiconductor layer; and

a tapered rib waveguide disposed in the semiconductor layer proximate to the buried

tapered waveguide, the tapered rib waveguide including a rib portion adjoining a slab

portion, the slab portion of the rib waveguide adjoining the buried tapered waveguide,

wherein an optical beam is directed into a larger end of the buried tapered waveguide and the

tapered rib waveguide, the buried tapered waveguide tapered to guide the optical beam

therethrough into the slab portion of the rib waveguide, wherein a vertical height of the

buried tapered waveguide at the larger end and at a smaller end opposite the larger end are

substantially similar.

2. (Original) The apparatus of claim 1 further comprising an insulator disposed in the

semiconductor layer, the insulator surrounding and serving as cladding for the buried tapered

waveguide to provide vertical and lateral optical confinement in the buried tapered

waveguide.

3. (Currently amended) The apparatus of claim 2 wherein [[a]] the smaller end of the

buried tapered waveguide opposite the larger end of the buried tapered waveguide is defined

by the insulator disposed in the semiconductor layer.

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(Original) The apparatus of claim3 wherein the insulator comprises oxide grown in a 4.

tapered trench etched from the semiconductor layer.

5. (Original) The apparatus of claim 3 wherein the buried tapered waveguide and the

tapered rib waveguide comprise epitaxial lateral overgrowth (ELO) silicon defined within the

oxide.

6. (Currently amended) The apparatus of claim 1 wherein the buried tapered waveguide

includes a first and second <u>lateral</u> taper regions, the first <u>lateral</u> taper region tapering at a first

lateral taper rate from the larger end of the buried tapered waveguide to the second lateral

taper region of the buried tapered waveguide, the second <u>lateral</u> taper region tapering at a

second lateral taper rate from the first <u>lateral</u> taper region of the buried tapered waveguide to

[[a]] the smaller end of the buried tapered waveguide, wherein the first <u>lateral</u> taper rate is

greater than the second <u>lateral</u> taper rate.

7. (Currently amended) The apparatus of claim 1 wherein the tapered rib waveguide

includes a first and second lateral taper regions, the first lateral taper region tapering at a

third taper rate from the larger end of the tapered rib waveguide to the second <u>lateral</u> taper

region of the tapered rib waveguide, the second <u>lateral</u> taper region tapering at a fourth <u>lateral</u>

taper rate from the first <u>lateral</u> taper region of the tapered rib waveguide to [[a]] the smaller

end of the tapered rib waveguide, wherein the third <u>lateral</u> taper rate is greater than the fourth

lateral taper rate.

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8. (Currently amended) A method, comprising:

directing an optical beam into a larger end of a buried tapered waveguide and a

tapered rib waveguide disposed in a semiconductor layer, the tapered rib waveguide

including a rib portion adjoining a slab portion, the slab portion of the rib waveguide

adjoining the buried tapered waveguide;

directing a mode of the optical beam propagating through the buried tapered

waveguide into the slab portion of the rib waveguide adjoining the buried tapered waveguide;

and

outputting substantially all of the optical beam directed into the larger end of the

buried tapered waveguide and the tapered rib waveguide from a smaller end of the tapered

rib waveguide, the smaller end of the tapered rib waveguide opposite the larger end of the

tapered rib waveguide, wherein a vertical height of the buried tapered waveguide at the larger

end and at the smaller end are substantially similar.

9. (Original) The method of claim 8 further comprising shrinking a mode size of the

optical beam from a larger mode size when directed into the larger end of the buried tapered

waveguide and the tapered rib waveguide to a smaller mode size when output from the

smaller end of the tapered rib waveguide.

10. (Currently amended) The method of claim 9 wherein shrinking the mode size of the

optical beam comprises:

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shrinking the mode size of the optical beam at a first <u>lateral</u> taper rate when the

optical beam is directed into the larger end of the buried tapered waveguide and the tapered

rib waveguide; and

shrinking the mode size of the optical beam at a second <u>lateral</u> taper rate when

directing the mode of the optical beam propagating through the buried tapered waveguide

into the slab portion of the rib waveguide adjoining the buried tapered waveguide.

11. (Currently amended) The method of claim 10 wherein the first <u>lateral</u> taper rate is

greater than the second <u>lateral</u> taper rate.

(Original) The method of claim 8 wherein directing the optical beam into the larger 12.

end of the buried tapered waveguide and the tapered rib waveguide includes directing the

optical beam from an optical fiber.

(Original) The method of claim 8 further comprising directing the optical beam from 13.

the smaller end of the tapered rib waveguide into a semiconductor photonic device disposed

in the semiconductor layer.

14. (Currently amended) A method, comprising:

etching a first semiconductor layer of a silicon-on-insulator (SOI) wafer with a first

mask;

etching a buried taper opening into a second semiconductor layer of the SOI wafer

with a buried taper mask, the buried taper mask having a larger end and a smaller end,

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wherein a vertical height of the buried tapered opening at the larger end and at the smaller

end are substantially similar;

growing an insulating layer in the buried taper opening;

growing silicon in and over the buried taper opening over the insulator layer to form a

buried tapered waveguide; and

patterning a tapered rib waveguide in the silicon grown over the buried tapered

waveguide using a tapered rib waveguide mask such that a slab portion of the tapered rib

waveguide adjoins the buried tapered waveguide, the tapered rib waveguide having a larger

end and a smaller end corresponding to the larger and smaller ends, respectively, of the

buried tapered waveguide.

(Original) The method of claim 14 further comprising sharpening a tip of the buried 15.

tapered waveguide defined at the smaller end of the buried taper opening by growing the

insulating layer in the buried taper opening.

(Currently amended) The method of claim 14 wherein etching the buried taper 16.

opening into the second semiconductor layer of the SOI wafer with the buried taper mask

includes defining first and second lateral taper regions in the buried tapered waveguide, the

first <u>lateral</u> taper region of the buried tapered waveguide to taper at a first <u>lateral</u> taper rate

from the larger end of the buried tapered waveguide to the second <u>lateral</u> taper region of the

buried tapered waveguide, the second <u>lateral</u> taper region of the buried tapered waveguide to

taper at a second lateral taper rate from the first <u>lateral</u> taper region of the buried tapered

waveguide to the smaller end of the buried tapered waveguide.

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(Currently amended) The method of claim 16 wherein the first taper rate greater than 17.

the first lateral taper rate is greater than the second <u>lateral</u> taper rate.

18. (Currently amended) The method of claim 14 wherein patterning the tapered rib

waveguide in the silicon grown over the buried tapered waveguide using the tapered rib

waveguide mask includes defining first and second <u>lateral</u> taper regions in the tapered rib

waveguide, the first <u>lateral</u> taper region of the tapered rib waveguide to taper at a third <u>lateral</u>

taper rate from the larger end of the tapered rib waveguide to the second <u>lateral</u> taper region

of the tapered rib waveguide, the second lateral taper region of the tapered rib waveguide to

taper at a fourth lateral taper rate from the first lateral taper region of the tapered rib

waveguide to the smaller end of the tapered rib waveguide.

19. (Currently amended) The method of claim 18 wherein the third <u>lateral</u> taper rate

greater than the fourth lateral taper rate.

(Original) The method of claim 14 further comprising optically coupling an optical 20.

fiber to the larger ends of the buried tapered waveguide and the tapered rib waveguide.

(Original) The method of claim 14 further comprising optically coupling a photonic 21.

device disposed in the SOI wafer to the smaller end of the tapered rib waveguide.

(Currently amended) A system, comprising: 22.

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an optical transmitter to transmit an optical beam;

an optical receiver; and

an optical device disposed between the optical transmitter and the optical receiver, the

optical device including:

a buried tapered waveguide disposed in a semiconductor layer;

a tapered rib waveguide disposed in the semiconductor layer proximate to the buried

tapered waveguide, the tapered rib waveguide including a rib portion adjoining a slab

portion, the slab portion of the rib waveguide adjoining the buried tapered waveguide,

wherein an optical beam is directed into a larger end of the buried tapered waveguide and the

tapered rib waveguide, the buried tapered waveguide tapered to guide the optical beam

therethrough into the slab portion of the rib waveguide, wherein a vertical height of the

buried tapered waveguide at the larger end and at a smaller end opposite the larger end are

substantially similar; and

a photonic device disposed in the semiconductor layer optically coupled to the

smaller end of the tapered rib waveguide,

the optical beam optically coupled to be received from the optical transmitter by the

buried tapered waveguide and the tapered rib waveguide, the optical beam to be directed

from the tapered rib waveguide through the photonic device to the optical receiver.

23. (Original) The system of claim 22 further comprising an optical fiber optically

coupled between the optical transmitter and the buried tapered waveguide and the tapered rib

waveguide.

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- (Original) The system of claim 22 wherein the optical device further comprises an 24. insulator disposed in the semiconductor layer, the insulator surrounding and serving as cladding for the buried tapered waveguide to provide vertical and lateral optical confinement in the buried tapered waveguide.
- (Currently amended) The system of claim 24 wherein [[a]] the smaller end of the 25. buried tapered waveguide opposite the larger end of the buried tapered waveguide is defined by the insulator disposed in the semiconductor layer.
- (Currently amended) The system of claim 22 wherein the buried tapered waveguide 26. includes a first and second <u>lateral</u> taper regions, the first <u>lateral</u> taper region tapering at a first lateral taper rate from the larger end of the buried tapered waveguide to the second <u>lateral</u> taper region of the buried tapered waveguide, the second lateral taper region tapering at a second lateral taper rate from the first lateral taper region of the buried tapered waveguide to [[a]] the smaller end of the buried tapered waveguide, wherein the first lateral taper rate is greater than the second <u>lateral</u> taper rate.
- (Currently amended) The system of claim 22 wherein the tapered rib waveguide 27. includes a first and second <u>lateral</u> taper regions, the first <u>lateral</u> taper region tapering at a third lateral taper rate from the larger end of the tapered rib waveguide to the second lateral taper region of the tapered rib waveguide, the second lateral taper region tapering at a fourth lateral taper rate from the first lateral taper region of the tapered rib waveguide to [[a]] the

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smaller end of the tapered rib waveguide, wherein the third <u>lateral</u> taper rate is greater than the fourth <u>lateral</u> taper rate.

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